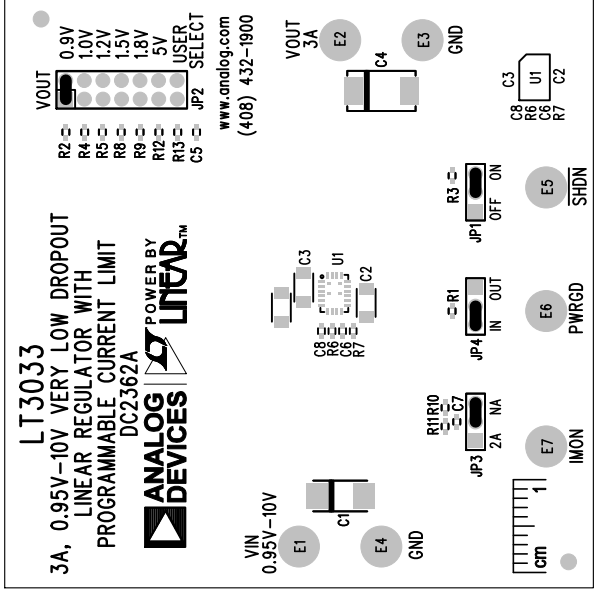
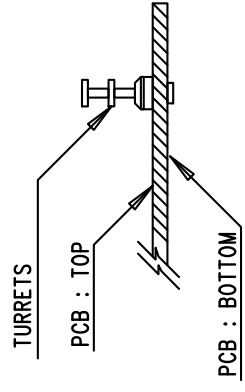


# NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.  
MAXIMUM SOLDER TEMPERATURE IS 240 DEG C.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS.  
LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER.  
MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE  
BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP  
TO ANY BOARD.



ANALOG DEVICES

POWER BY LINEAR™

www.analog.com (408) 432-1900

TITLE: TOP ASSEMBLY DRAWING			
3A, 0.95V-10V VERY LOW DROPOUT LINEAR REGULATOR WITH PROGRAMMABLE CURRENT LIMIT			
SIZE	IC NO.	REV.	
N/A	LT3033EUDC DC2362A	4	
FILENAME: DC2362A-4.PCB		SHT 1 OF 1	